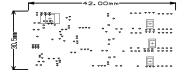
PCB Dimentions: 42mm x 30.5mm



LAYER STACK TABLE

Layer	Name	Material	Thickness	
	Top Overlay			
	Top Solder	Solder Resist	O. 010mm	
1	Top S.Layer	Copper	0.035mm	
	Dielectric 2	7628H	0.200mm	
2	GND	Copper	0.018mm	
	Dielectric 1	FR-4	1.065mm	
3	VCC	Copper	O. 018mm	
	Dielectric 3	7628H	0.200mm	
4	Bottom S.Layer	Copper	0.035mm	
	Bottom Solder	Solder Resist	O. 010mm	
	Bottom Overlay			
Total	1.591mm			

DRILL TABLE

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad
	6	0.200mm (7.87mil)	PTH	Round	Top S.Layer - Bottom S.Layer	Via
▽	68	O. 300mm <11.81mil>	PTH	Round	Top S.Layer - Bottom S.Layer	Vía
0	81	O.400mm <15.75mil>	PTH	Round	Top S.Layer - Bottom S.Layer	Via
	155 Total					

FABRICATION NOTES

- FABRICATION NOTES

 FABRICATE PER ANSI/IPC-A-600, IPC-QE-605, IPC-4101, IPC-4552 AND IPC-SM-840 SPECIFICATIONS. MATERIAL SASE MATERIAL ANIMATED EPOXY OLASS NEMA GRADE FR-4, NOM, 052, COLOR NATURAL. NOTITE OF THICKNESS OF HAMBORIA FER PLATING AND FILLS FOR THICKNESS OF HAMBORIA FER PLATING AND FILLS FOR THE PROPERTY OF HAMBORIA FER PLATING AND FILLS FOR THE PROPERTY OF HAMBORIA FER PLATING AND FILLS FOR THE PROPERTY OF HAMBORIA FER PLATING AND FILLS FOR THE PROPERTY OF HAMBORIA FER PLATING AND FILLS FOR THE PROPERTY OF THE

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